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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application:
Michael Vyvoda, et al.

Serial No.: 10/045,653

Filed: November 7, 2001

For: Metal Structures for Integrated

Circuits and Methods for Making the Same

Confirmation No. 9868

Group Art Unit: 2812

Examiner: Unassigned

Box Missing Parts Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

PRELIMINARY AMENDMENT

Prior to examination of this application on the merits, Applicants respectfully request entry of the following amendment.

IN THE CLAIMS

Please add the following claims.

--10. The method of claim 9, wherein a portion of the metal structure has a dimension greater than about 1 micron.

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D. C. 20231, on this 19th day of June 2002.

Signed.

Dated: (c/ 19/17)

- 11. The method of claim 10, wherein a portion of the metal structure has a dimension less than about 0.25 micron.
 - 12. A method for making a semiconductor device, comprising:

providing a metal structure on a substrate, the metal structure comprising tungsten and a portion of the metal structure having a dimension greater than about 1 micron; and

providing an insulating layer over the metal structure;

providing a capping structure over the insulating layer; and

annealing the resulting structure;

wherein the capping structure and annealing decreases peeling of the metal structure when heated.

13. A method for making a semiconductor device, comprising:

providing a metal structure on a substrate, the metal structure comprising tungsten and a portion of the metal structure having a dimension greater than about 1 micron; and

providing an insulating layer over the metal structure;

providing a capping structure over the insulating layer; and

annealing the resulting structure;

wherein the annealing decreases peeling of the metal structure when heated .--

REMARKS

Applicants hereby submit this Preliminary Amendment in response to the Notice of Missing Parts (the "Notice"). The Notice noted that the Office had not received several items that were originally filed, including page 16 of the specification and the filing fee.

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T, Applicants strongly disagree that these items were not part of the application as originally

filed. These items were actually submitted as part of the application, but were separated from the

application while being handled by the U.S. Postal Service at off-site storage because of anthrax

considerations. Unfortunately, the postcard receipt was also lost during this handling procedure.

Thus, Applicants were in a position of being unable to proof that page 16 of the specification was

submitted as part of the original application.

For cost and other considerations, Applicants did not petition this issue.

Applicants submit the information in page 16 of the specification via the present Preliminary

Amendment. Looking at page 15 of the specification (containing claims 1-9) and page 17 of the

specification (containing claims 14-18), it is obvious that page 16 of the specification contained

claims 10-13. These same claims 10-13 are now submitted via this Preliminary Amendment.

If there is any fee due in connection with the filing of this Preliminary Amendment.

including a fee for any extension of time not accounted for above, please charge the fee to our

Deposit Account No. 18-0013.

Respectfully Submitted,

By

KENNETH E. HORTON

Reg. No. 39,481

Date: June 19, 2002